1318123-1 ✓ ACTIVE

Dynamic Series | Dynamic 2000 Series

TE Internal #: 1318123-1

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [. 099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder,

Dynamic 2000 Series

View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > Header Assembly: Wire-to-Board, 5A, gold plated



Connector System: Wire-to-Board

Number of Positions: 3 Number of Rows: 1

Centerline (Pitch): 2.5 mm [.099 in] PCB Mount Orientation: Vertical

All Header Assembly: Wire-to-Board, 5A, gold plated (44)

Features

Product Type Features		
Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	3	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Body Features		
Primary Product Color	Black	
Contact Features		
Contact Mating Area Plating Material Thickness	.38 μm[15 μin]	
Contact Mating Area Plating Material	Gold	

Pin

5 A

Contact Type

Contact Current Rating (Max)



Termination Features

Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	

Mating Alignment Type	Keyed
Mating Retention	With
PCB Mount Retention Type	Retention Leg
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	With

Housing Features

Housing Material	Polyester GF
Centerline (Pitch)	2.5 mm[.099 in]

Usage Conditions

Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]

Operation/Application

Circuit Application	Power & Signal

Industry Standards

V-O
V

Packaging Features

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900



ppm.

Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



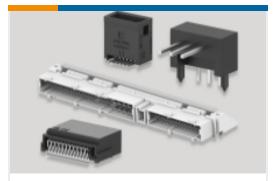
Also in the Series | Dynamic 2000 Series



Insertion & Extraction Tools(1)



PCB Connector Mounting(4)



PCB Headers & Receptacles(44)



PCB Terminal Blocks(23)



Wire-to-Board Connector Assemblies & Housings(54)



Customers Also Bought









Documents

Product Drawings

DYNAMIC D2100 HDR V ASSY 3P

Japanese

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1318123-1_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1318123-1_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1318123-1_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773721-5_DYNAMIC_SERIES_QRG

English

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

Japanese

1-1773732-4_DYNAMIC_SERIES_CATALOG_ENGLISH

English

Product Specifications

Dynamic Connector D-2000 Series

Japanese

Application Specification

Japanese

Product Environmental Compliance

MD_1318123-1_091820181437_dmtec

English

MD_1318123-1_091820181437_dmtec

PCB Mount Header, Vertical, Wire-to-Board, 3 Position, 2.5 mm [.099 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Dynamic 2000 Series



English

Agency Approvals

Agency Approval Document

English